

Product Features

- 1930 1990 MHz
- 32.5 dB Gain
- +36 dBm P1dB
- -62 dBc ACPR @ 27 dBm IS-95A linear power
- -55 dBc ACLR @ 26.5 dBm wCDMA linear power
- +12 V Single Supply
- Power Down Mode
- Bias Current Adjustable
- RoHS-compliant flange-mount pkg

Applications

- Final stage amplifiers for repeaters
- Optimized for driver amplifier PA mobile infrastructure

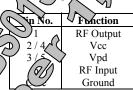
Product Description

The AP501 is a high dynamic range power amplifier in a RoHS-compliant flange-mount package. The multi-stage amplifier module has 32.5 dB gain, while being able to achieve high performance for PCS-band applications with +36 dBm of compressed 1dB power. The module has been internally optimized for driver applications provide -62 dBc ACPR at 27 dBm for IS-95A applications or -55 dBc ACLE at 26.5 for wCDMA applications. The module can be bia down for current when higher efficiency is required.

The AP501 uses a high reliability InGaP/GaAs HBT r technology and does not require any external matching components. The module operates off a +12 does not requiring any negative biasing voltaactive bias allows the amplifier to main over temperature. It has the added feature down control pin. A low-cost met device to have a low thermal resista lifetimes. All devices are 100% R and DC teste

The AP501 is targeted for y in wireless infrastructure w required. This combination candidate for next gener

Functional Dia



Specifications

25 °C, V_{cc}=12V, V_{pd}=5V, I_{cq}=820mA, R7=0Ω, 50Ω unma

Parameter	Units	Min	Max
Operational Bandwidth	MHz	15 (2)	0
Test Frequency	MHz	(2)800	(0)
Power Gain	dB	2.4	(62)
IS-95A ACPR @ 27dBm (1)	dBc	-61.8	35
wCDMA ACLR @ 26.5dBm (2)	dBc	-5(7)	\sim
Input Return Loss	db C	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	/ (0
Output Return Loss	40		V
Output P1dB	CADO	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	P
Output IP3	(m)	+52	
Operating Current @ 27 dBm(\int mA	(9) 84 (9)	940
Quiescent Current, Icq	m_{A}		920
Device Voltage, Vcc	27.0	0/2	
Device Voltage, Vp	(0)	+5	
Load Stability \	YSWR		
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Ι.	18-95A signal mo	on, annels forv	Q, Y3 MHZ BW KHZ Offset.
2.	3GPP wCDMA	an Julation, Test	32 DPCH, 3.84 MHz BW, ±5 MHz offset.
2	D. 11 J	Lari been Ara	′

O)arame (r	Units	Config1	Config2
Opera Current @ 27 dBm	mA	840	420
Qy mt Current, Icq	mA	820	250
V Voltage, Vcc	V	+12	+12
Value	Ω	0	730
Test Frequency	MHz	1960	1960
Power Gain	dB	32.4	30.5
IS-95A ACPR @ 27dBm (1)	dBc	-61.8	-53
wCDMA ACLR @ 26.5dBm (2)	dBc	-55	-49
Input Return Loss	dB	22	20
Output Return Loss	dB	6	8
Output P1dB	dBm	+36	+36
Output IP3	dBm	+52	+52

Configuration 1 has the module biased in Class AB and is detailed on page 2 of the datasheet. Performance is shown at 25 °C, Vcc=12V, Vpd=5V, Icq=820mA, R7=0 $\Omega$ , 50 $\Omega$  unmatched fixture. Configuration 2 has the module biased in near Class B and is detailed on page 3 of the datasheet. Performance is shown at 25 °C, Vcc=12V, Vpd=5V, Icq=250mA, R7=730 $\Omega$ , 50 $\Omega$  tuned fixture.

Paramete	Rating
Operation Case T/Operature	-40 to +85 °C
St ( mperatur	-55 to +150 °C
RF Powe ntinuous)	+15 dBm

## **Ordering Information**

Part No.	Description
AP501	PCS-band 4W HBT Amplifier Module
AP501-PCB	Fully-Assembled Evaluation Board (Class AB configuration, Icq=820mA)

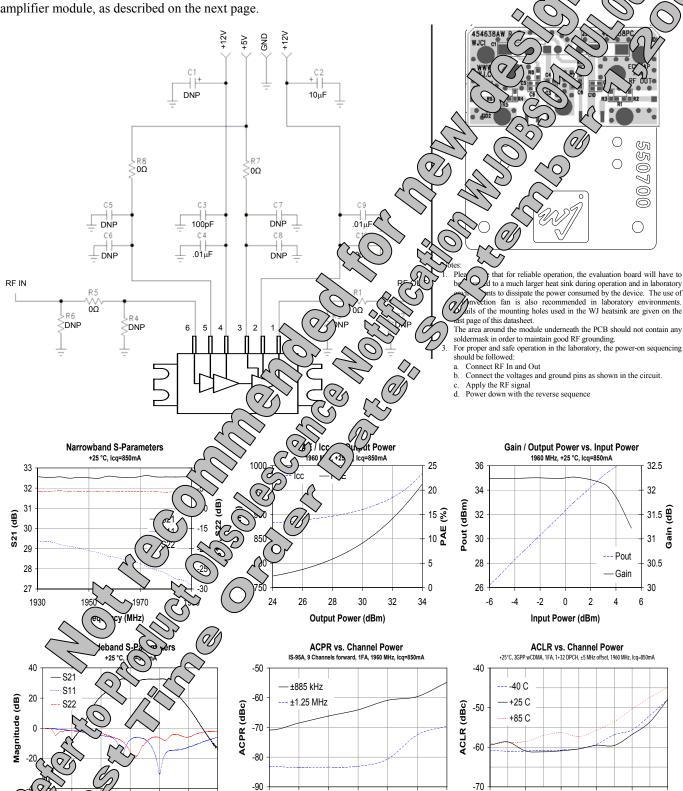
Specifications and information are subject to change without notice





## Performance Graphs - Class AB Configuration (AP501-R

The AP501-PCB and AP501 module is configured for Class AB by default. The resistor – R7 – which a current the amplifier is set at 0  $\Omega$  in this configuration. Increasing that value will decrease the quiescent arrangement amplifier module, as described on the next page.



Frequency (MHz)

Output Channel Power (dBm)

Specifications and information are subject to change without notice

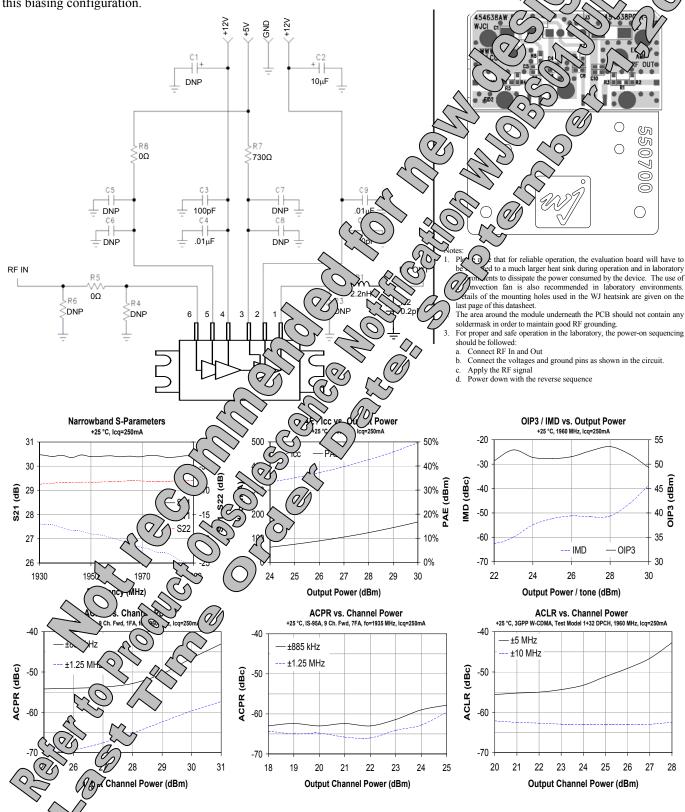
Output Channel Power (dBm)





## **Performance Graphs - Class B Configuration**

The AP501 can be adjusted to operate at lower current biasing levels by modifying the R7 resistor of performance. The configuration shown on this page has the AP501 operating with Icq = 250 mA (Icc) Output L-C matching components have been added externally on the circuit to optimize the amplification this biasing configuration.







#### **MTTF Calculation**

The MTTF of the AP501 can be calculated by first determining how much power is being dissipated by the amplifier module. Because the device's intended application is to be a power amplifier pre-driver or final stage output amplifier, the output RF power of the amplifier will help lower the overall power dissipation. In addition, the amplifier can be biased with different quiescent currents, so the calculation of the MTTF is custom to each application.

The power dissipation of the device can be calculated with the following equation:

$$\begin{split} P_{diss} &= V_{cc} * I_{cc} - (Output \ RF \ Power - Input \ RF \ Power), \\ V_{cc} &= Operating \ supply \ voltage = \textbf{12V} \\ I_{cc} &= Operating \ current \\ \{The \ RF \ power \ is \ converted \ to \ Watts\} \end{split}$$

While the maximum recommended case temperature on the datasheet is listed at 85 °C, it is suggested that customers maintain an MTTF above 1 million hours. This would convert to a derating curve for maximum case temperature power dissipation as shown in the plot below.

To calculate the MTTF for the thick temperature needs to be determ to this calculated with the module's property that the resistance value, and the case the third that the case the state of the case that the case the ca

$$T_j = P_{diss} * R_{th} + T_{e}$$
 $T_j = Junction$ 
 $P_{diss} = Power$ 
 $R_{th} = Thernal resistance$ 
 $T_{case} = C$ 
 $T_{case} = C$ 

From a num stands he from be calculated using the Art sequence of the sequence

A = Pre-er ential Each 
$$r = 6.087 \times 10^{-11}$$
 hours

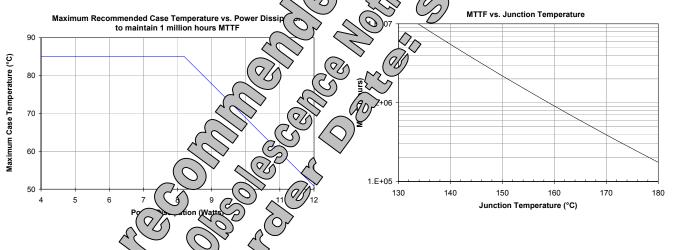
Sa = A contain Each  $r = 6.087 \times 10^{-11}$  hours

 $k = R$  contain  $r = 8.617 \times 10^{-5}$  eV/°K

 $r = R$  contain  $r = 8.617 \times 10^{-5}$  eV/°K

 $r = R$  contain  $r = R$  contains  $r =$ 

graph View MTTF can be shown in the plot



2x .360

4X Ø .102 MARKED 'A

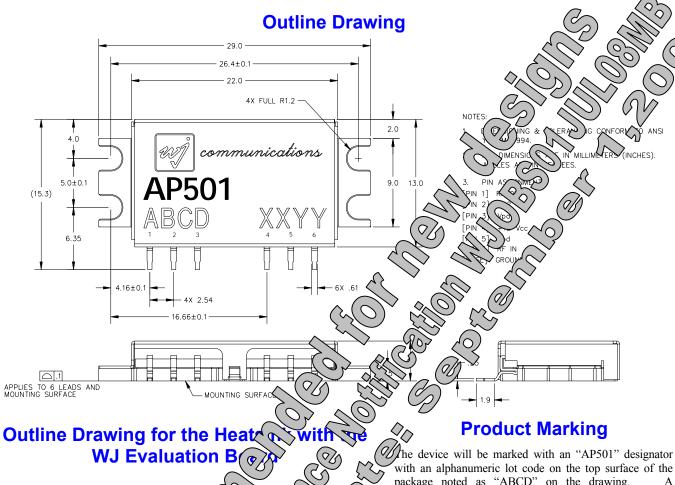
₹ .010

9X TAP .086-56 UNC

2X .170

2X 1.040





2X .196

2X 1.044

2X .390 .300

-2x .06x45

Α

2X 1.550

2X 250

package noted as "ABCD" on the drawing. manufacturing date will also be printed as "XXYY", where

The product will be shipped in tubes in multiples of 15.

the "XX" represents the week number from 1-52.

## **ESD / MSL Information**

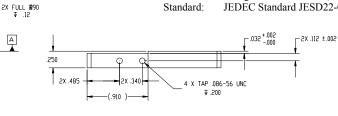


ESD Rating: Class 1C

Value: Passes at  $\geq 1,000$  to  $\leq 2,000$  volts Human Body Model (HBM) Test: Standard: JEDEC Standard JESD22-A114

ESD Rating: Class III

Value: Passes  $\geq$  500 to < 1,000 volts Test: Charged Device Model (CDM) Standard: JEDEC Standard JESD22-C101



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